

High Efficiency Bi-Direction Power Bank Regulator for Single-Cell Battery Power Bank

General Description

SY6918A is a 5V adapter input with up to 18V surge bi-directional regulator designed for single cell Li-Ion battery power bank application. Advanced bi-directional energy flow control with automatic input power source detection is adopted to achieve battery charging mode and battery power supply mode alternately.

SY6918A also integrates the KEY control and LED status indication.

SY6918A is available in QFN3x3 package to minimize the PCB layout size for wide portable applications.

Ordering Information

SY6918 ()
 └───┬─── Temperature Code
 └───┬─── Package Code
 └───┬─── Optional Spec Code

Ordering Number	Package type	Note
SY6918AQDC	QFN3x3-16	

Features

- Maximum 18V input Voltage Surge
- Bad Adapter Detection
- Build in Power Path NFETs and Power Switches
- 500kHz Switching Frequency Operation
- Trickle Current / Constant Current / Constant Voltage Charge Mode with Internal Compensation
- Maximum 2A Constant Charge Current
- Maximum 2.5A Boost Output Current
- 4.2V/4.35V Selectable Battery Cell Voltage
- +/-0.5% Cell Voltage Accuracy
- Charge/Discharge/Fault Status Indicator
- Key Controls Logic
- Boost Auto Start When Portable Device Inserts
- Boost Auto Shutdown with Light Load
- Programmable Input Current Limit
- Dynamic Power Management
- Cycle-by-Cycle Peak Current Limitation
- Input Voltage UVLO and OVP
- Boost Output Short Circuit Protection
- Thermal Shutdown

Applications

- 1-Cell Power Bank
- Portable Device with 1-Cell Battery

Typical Applications

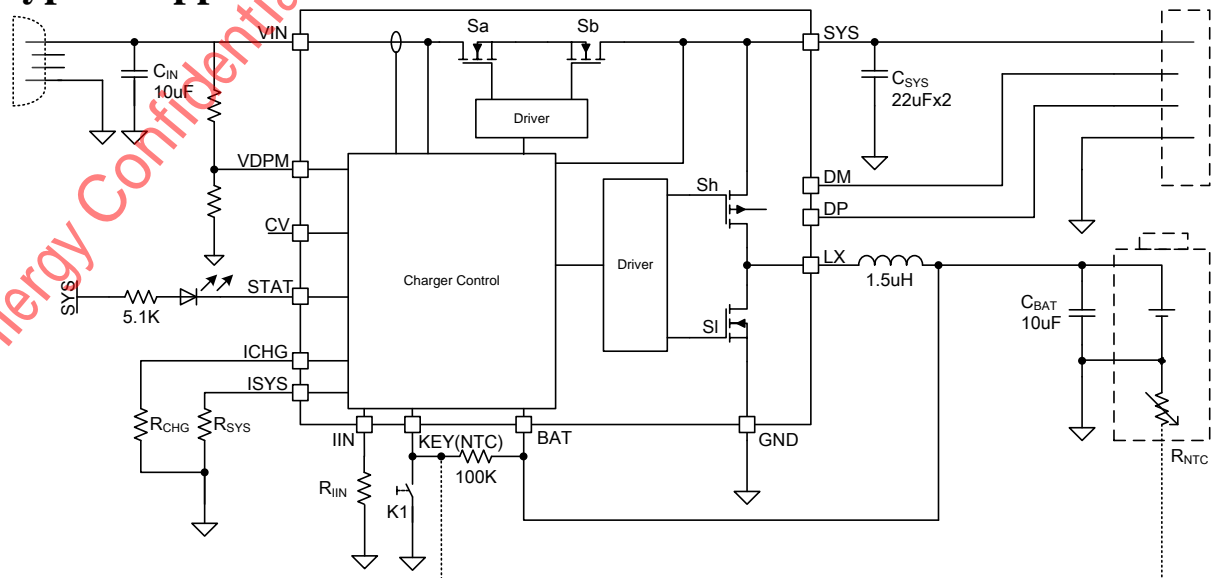
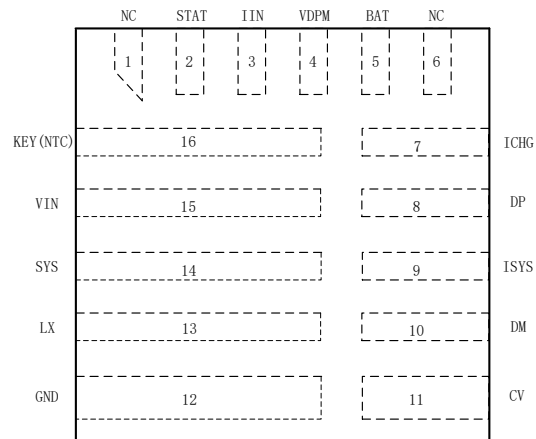


Figure1. Schematic Diagram

Pinout (top view)



(QFN3x3-16FC)

Top Mark: **BOP**_{xyz}, (Device code: BOP, *x*=year code, *y*=week code, *z*=lot number code)

Name	No	Description
NC	1	Not connected.
STAT	2	Charge or discharge status indication pin. Open drain output. Pull high to SYS through a LED to indicate the charge or discharge in process. When the charge is done, LED is off. This LED is also used as fault indicator.
IIN	3	Connect a resistor to set the input current limit in Buck mode.
VDPM	4	Voltage sense for input dynamic management. If the voltage drops to the internal 1.2V reference voltage, the VIN will be clamped to the setting value.
BAT	5	Battery voltage sense pin. Used as battery constant voltage control and battery voltage protections.
NC	6	Not connected.
ICHG	7	Connect a resistor to set charge current limit in Buck mode.
DP	8	D+/D- output for USB port connection. It supports BC1.2 handshaking, And also
DM	10	supports Apple and Samsung portable device.
ISYS	9	Connect a resistor to set SYS current limit in boost mode.
CV	11	Charge voltage selection pin. Open or pull low for 4.2V. Pull high for 4.35V
GND	12	Power ground.
LX	13	Switch node pin. Connect to external inductor.
SYS	14	System connection point. Add at least 2pcs of 22uF MLCC here.
VIN	15	Power input pin. Connect a MLCC from this pin to ground to decouple high harmonic noise. This pin has OVP and UVLO function to make the charger operate within safe input voltage area.
KEY	16	Press key and battery thermal sense pin. Pull up to BAT with the resistor. Connect to the NTC to achieve battery thermal protection. Disable thermal protection without pull-down resistor



Absolute Maximum Ratings

VIN	-----	-0.3-18V
LX, SYS, STAT, IIN, VDPM, CV, ICHG, ISYS, DP, DM, BAT, KEY	-----	-0.3-6V
VIN Pin Current Continuous	-----	2.5A
SYS Pin Current Continuous	-----	3.5A
LX Pin Current Continuous	-----	8A
Power Dissipation, Pd @ TA = 25 °C, QFN3×3	-----	2.1W
Package Thermal Resistance		
θJA	-----	48°C/W
θJC	-----	4°C/W
Junction Temperature Range	-----	-40 °C to 150 °C
Lead Temperature (Soldering, 10 sec.)	-----	260 °C
Storage Temperature Range	-----	-65 °C to 125 °C

Recommended Operating Conditions

VIN	-----	0-5.5V
LX, SYS, STAT, IIN, VDPM, CV, ICHG, ISYS, DP, DM, BAT, KEY	-----	0-5.5V
VIN Pin Current Continuous	-----	2.0A
SYS Pin Current Continuous	-----	2.5A
LX Pin Current Continuous	-----	6A
Junction Temperature Range	-----	-40 °C to 125 °C
Ambient Temperature Range	-----	-40 °C to 85 °C

Silergy Confidential-For 半导体芯

Electrical Characteristics

T_J=25 °C, V_{IN}=5V, C_{IN}=10 μF, C_{BAT}=10 μF, C_{SYS}=44 μF, L=1.5 μH, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Bias Supply (V_{IN})						
V _{IN}	Input Voltage Operation Range		4.5		5.35	V
V _{INOK}	Adapter OK Voltage	Rising edge	4.35	4.5	4.65	V
ΔV _{INOK}	Adapter OK Voltage Hysteresis	Falling edge		200		mV
V _{OVP}	Input Overvoltage Protection	Rising edge	5.75	5.95	6.15	V
ΔV _{OVP}	Input Overvoltage Protection Hysteresis	Falling edge		200		mV
V _{DPM}	Input Voltage REF for Adaptive Input Current Limit		1.17	1.2	1.23	V
Quiescent Current						
I _{BAT}	Battery Discharge Current	Boost shutdown, V _{KEY} =V _{BAT}			20	μA
I _{IN}	Input Quiescent Current	Disable charge			1.5	mA
Oscillator and PWM						
f _{OSC}	Switching Frequency			500		kHz
Power MOSFET						
R _{HIGH}	R _{DS(ON)} of High side P-FET	R _{SH}		35		mΩ
R _{LOW}	R _{DS(ON)} of Low side N-FET	R _{SL}		20		mΩ
R _{PM}	R _{DS(ON)} of Power Path Management N-FET	R _{SA} +R _{SB}		80		mΩ
I _{CHG_MAX}	Peak Current of Switching FETs on Charge mode			4.5		A
I _{DIS_MAX}	Peak Current of Switching FETs on Discharge mode			8		A
Voltage Threshold and Regulation						
V _{CV}	Cell Voltage Tolerance	V _{CV} =4.35V	4.324	4.35	4.376	V
ΔV _{RCH}	CV Hysteresis for Recharge	V _{CV} =4.35V	50	100	150	mV
V _{SYS}	Discharge Output Voltage at SYS	V _{BAT} =3.7V	5.05	5.15	5.25	V
Current Regulation						
I _{CC}	Internal Charge Current Accuracy for Constant Current Mode	R _{CHG} =2.55k (I _{CC} =2A)	-10		10	%
I _{TC}	Internal Charge Current for Trickle Current Mode	R _{CHG} =2.55k (I _{CC} =2A)		0.1		I _{CC}
I _{TERM}	Termination Current	R _{CHG} =2.55k (I _{CC} =2A)		0.1		I _{CC}
I _{INDPM}	Maximum Input Current Limit When Charger is Switching.	R _{IN} =0.78k, I _{CHG} =1A	2.25	2.5	2.75	A
I _{SYS_LL}	SYS Current with Light Boost Load for Boost Auto Shutdown	V _{BAT} =3.7V, R _{SYS} =2.2k	25	50	75	mA
System and BAT OVP						
V _{SYS_OVP}	SYS Voltage OVP Threshold	Rising edge	103%	105%	107%	V _{SYS}
ΔV _{SYS_OVP}	SYS Voltage OVP Hysteresis	Falling edge		2%		V _{SYS}
V _{BAT_OVP}	BAT Voltage OVP Threshold	Rising edge	103%	105%	107%	V _{CV}
ΔV _{BAT_OVP}	BAT Voltage OVP Hysteresis	Falling edge		2%		V _{CV}
Battery Weak						
V _{DPL}	Battery Depletion Threshold	Falling edge		2.5		V
ΔV _{DPL}	Battery Depletion Hysteresis	Rising edge		300		mV
V _{TRK}	Battery Trickle Charge Threshold	Falling edge	2.5	2.6	2.7	V
ΔV _{TRK}	Battery Trickle Charge Hysteresis	Rising edge		200		mV

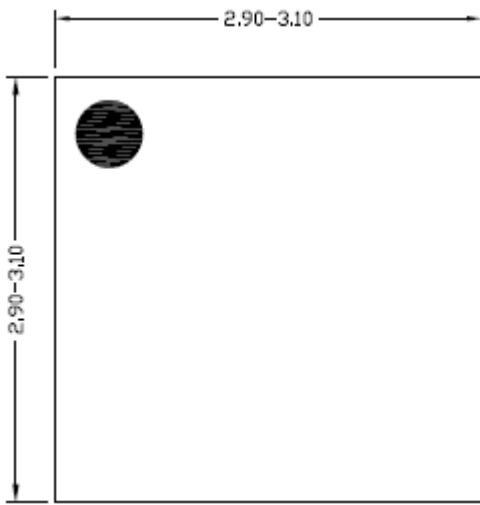
BAT Short Protection						
V _{SHORT}	Output Short Protection Threshold	V _{BAT} falling edge	1.9	2.0	2.1	V
SYS Over Current Protection						
I _{SYSMAX}	SYS Current Limit On Boost Mode	V _{BAT} =3.7V, R _{SYS} =2.2k	2.25	2.5	2.75	A
Timing						
T _{TC}	Trickle Current Charge Timeout			2		hour
T _{OC}	ACOC Deglitch Time			600		μs
T _{SYS_LL}	SYS Light Load Deglitch Time			20		s
Battery Thermal Protection						
V _{UTP}	UTP Threshold	Rising edge	65.7%	67.7%	69.7%	V _{BAT}
	UTP Hysteresis	Falling edge		3.5%		V _{BAT}
V _{OTP}	OTP Threshold	Falling edge	29.9%	31.9%	33.9%	V _{BAT}
	OTP Hysteresis	Rising edge		2%		V _{BAT}
V _{NTCHIGH}	High Voltage to Disable NTC Function	Rising edge		90%		V _{BAT}
V _{KEY}	KEY Active Low Voltage	Falling edge		0.35		V
Thermal Regulation and Thermal Shutdown						
T _{TSD}	Thermal Shutdown Threshold			150		°C
ΔT _{TSD}	Thermal Shutdown Hysteresis			30		°C

Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

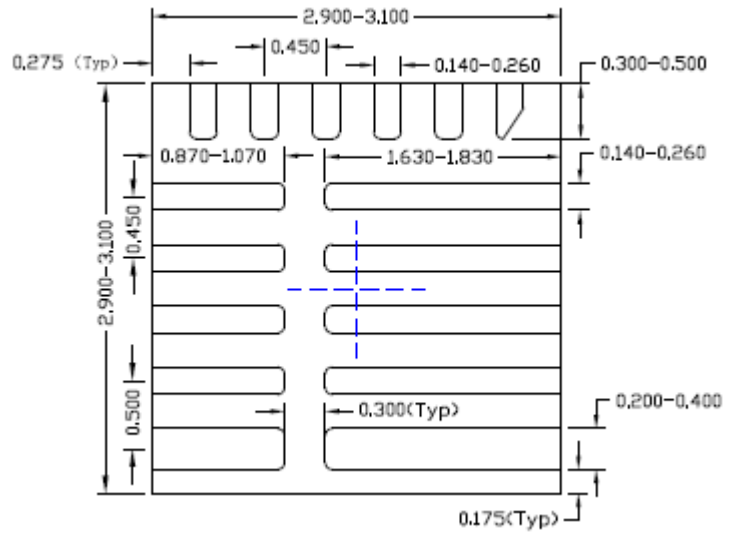
Note 2: θ_{JA} is measured in the natural convection at $T_A = 25\text{ °C}$ on a low effective four-layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 3: The device is not guaranteed to function outside its operating conditions.

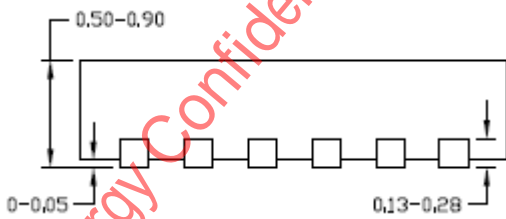
QFN3×3-16 Package Outline Drawing



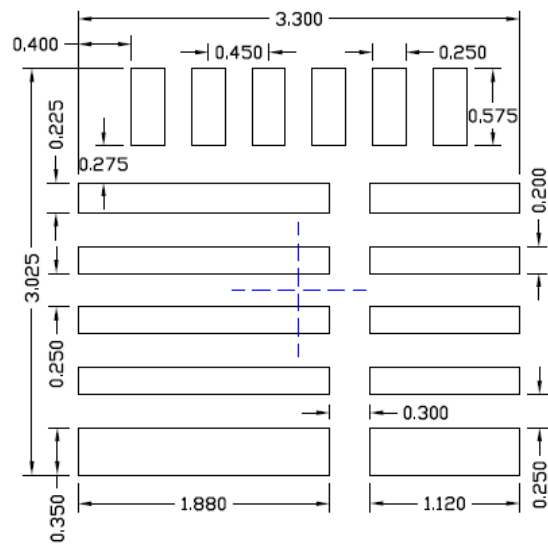
Top View



Bottom View



Side View



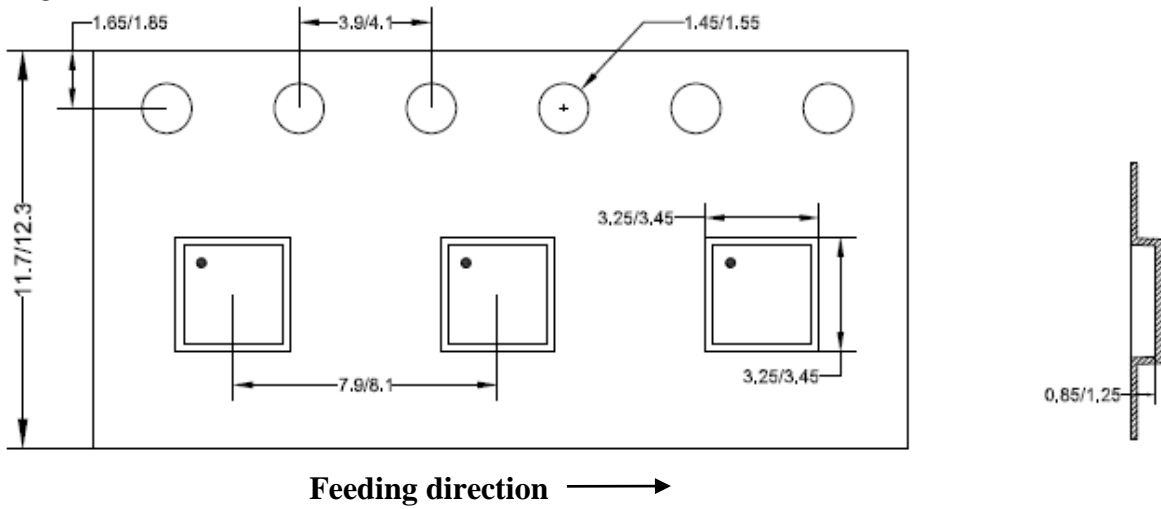
**Recommended PCB layout
(Reference Only)**

Notes: All dimension in millimeter and exclude mold flash & metal burr

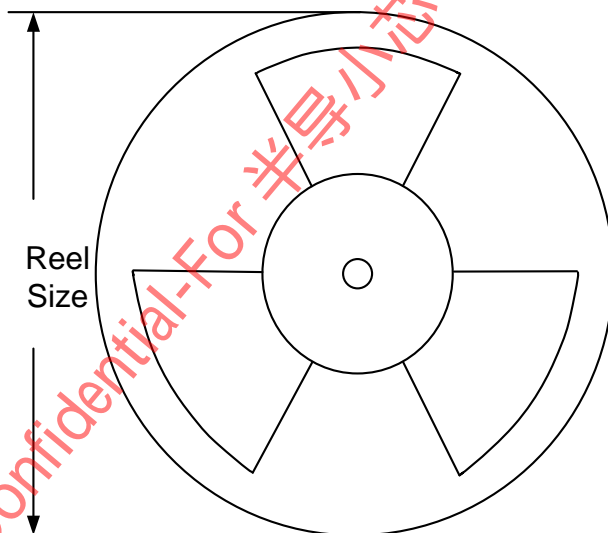
Taping & Reel Specification

1. Taping orientation

QFN3×3



2. Carrier Tape & Reel specification for packages



Package types	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
QFN3×3	12	8	13"	400	400	5000

3. Others: NA